

L Number	Hits	Search Text	DB	Time stamp
1	4552	optoelectronic and lens\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/03 12:30
2	2634	(solder near bump\$1) and ((metal\$8 near pattern) or (bonding near pad\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/03 12:32
3	65	(optoelectronic and lens\$2) and ((solder near bump\$1) and (metal\$8 near pattern) or (bonding near pad\$1)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/03 12:32